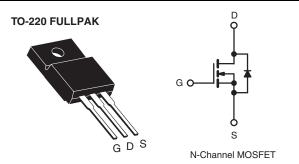


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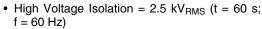
### **Power MOSFET**

PRODUCT SUMMARY			
V <sub>DS</sub> (V)	200		
$R_{DS(on)}\left(\Omega\right)$	V <sub>GS</sub> = 5.0 V	0.18	
Q <sub>g</sub> (Max.) (nC)	66		
Q <sub>gs</sub> (nC)	9.0		
Q <sub>gd</sub> (nC)	38		
Configuration	Single		



#### **FEATURES**

· Isolated Package





RoHS COMPLIANT

- Sink to Lead Creepage Dist. 4.8 mm
- · Logic-Level Gate Drive
- R<sub>DS(on)</sub> Specified at V<sub>GS</sub> = 4V and 5 V
- · Fast Switching
- · Ease of paralleling
- Lead (Pb)-free Available

#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 FULLPAK eliminates the need for additional insulating hardware in commercial-industrial applications. The molding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The FULLPAK is mounted to a heatsink using a single clip or by a single screw fixing.

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	IRLI640GPbF
Lead (PD)-liee	SiHLI640G-E3
SnPb	IRLI640G
	SiHLI640G

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		$V_{DS}$	200	V	
Gate-Source Voltage	$V_{GS}$	± 10			
Continuous Drain Current	$V_{GS}$ at 5.0 V $T_C = 25 ^{\circ}C$	I <sub>D</sub>	9.9	А	
	$T_C = 100 ^{\circ}C$		6.3		
Pulsed Drain Current <sup>a</sup>	I <sub>DM</sub>	40			
Linear Derating Factor			0.32	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>	E <sub>AS</sub>	290	mJ		
Repetitive Avalanche Currenta	I <sub>AR</sub>	9.9	A		
Repetitive Avalanche Energy <sup>a</sup>	E <sub>AR</sub>	4.0	mJ		
Maximum Power Dissipation	T <sub>C</sub> = 25 °C	$P_{D}$	40	W	
Peak Diode Recovery dV/dtc	dV/dt	5.0	V/ns		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for 10 s	•	300 <sup>d</sup>	7	
Mounting Torque	6-32 or M3 screw		10	lbf ⋅ in	
	b-3≥ of M3 screw		1.1	N · m	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD} = 25 \text{ V}$ , starting  $T_J = 25 \,^{\circ}\text{C}$ ,  $L = 4.4 \,\text{mH}$ ,  $R_G = 25 \,\Omega$ ,  $I_{AS} = 9.9 \,\text{A}$  (see fig. 12). c.  $I_{SD} \le 17 \,\text{A}$ ,  $\text{dI/dt} \le 150 \,\text{A/µs}$ ,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150 \,^{\circ}\text{C}$ .
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

# IRLI640G, SiHLI640G

# Vishay Siliconix



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	65	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	3.1	C/VV	

PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		200	-	-	٧
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I <sub>D</sub> = 1 mA		-	0.27	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$		1.0	-	2.0	V
Gate-Source Leakage	I <sub>GSS</sub>	,	V <sub>GS</sub> = ± 10 V		-	± 100	nA
Zawa Oata Valtana Dusin Oamant	I <sub>DSS</sub>	V <sub>DS</sub> =	V <sub>DS</sub> = 200 V, V <sub>GS</sub> = 0 V		-	25	μΑ
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 160 V	V <sub>DS</sub> = 160 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 160 °C		-	250	
Drain-Source On-State Resistance	_	V <sub>GS</sub> = 5.0 V	I <sub>D</sub> = 5.9 A <sup>b</sup>	-	-	0.18	Ω
	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.0 V	I <sub>D</sub> = 5.0 A <sup>b</sup>	-	-	0.27	
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> :	$V_{DS} = 50 \text{ V}, I_{D} = 10 \text{ A}^{b}$		-	-	S
Dynamic		•					
Input Capacitance	C <sub>iss</sub>		$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$		1800	-	pF
Output Capacitance	C <sub>oss</sub>	1			400	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0 MHz, see fig. 5		-	120	-	
Total Gate Charge	Qg			-	-	66	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_D = 17 \text{ A}, V_{DS} = 160 \text{ V},$ see fig. 6 and 13 <sup>b</sup>	-	-	9.0	nC
Gate-Drain Charge	Q <sub>gd</sub>	1	See lig. 6 and 16	-	-	38	
Turn-On Delay Time	t <sub>d(on)</sub>		1		8.0	-	- ns
Rise Time	t <sub>r</sub>	$V_{DD} = 100 \text{ V, } I_{D} = 17 \text{ A,}$ $R_{G} = 4.6 \Omega, R_{D} = 5.7 \Omega,$ see fig. $10^{b}$		-	83	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	44	-	
Fall Time	t <sub>f</sub>			-	52	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET sym	MOSFET symbol showing the		-	9.9	Α
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	40	^
Body Diode Voltage	$V_{SD}$	$T_J = 25$ °C	$T_J$ = 25 °C, $I_S$ = 9.9 A, $V_{GS}$ = 0 $V^b$		-	2.0	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = 17 A, dl/dt = 100 A/μs <sup>b</sup>		-	310	470	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			_	3.2	4.8	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )				L <sub>D</sub> )	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq$  300  $\mu s;$  duty cycle  $\leq$  2 %.



### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

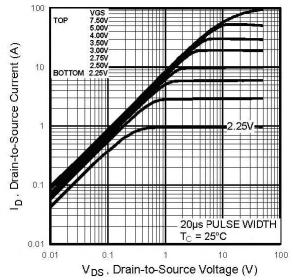


Fig. 1 - Typical Output Characteristics,  $T_C = 25$  °C

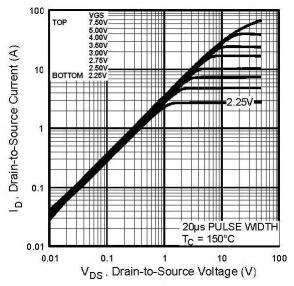


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 150 °C

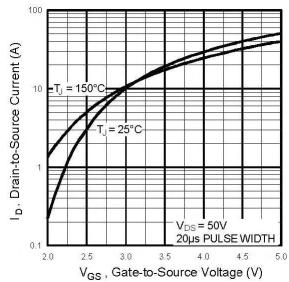


Fig. 3 - Typical Transfer Characteristics

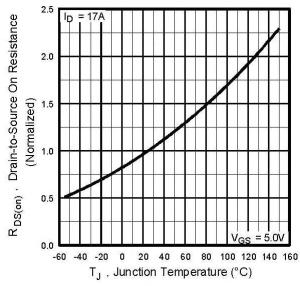
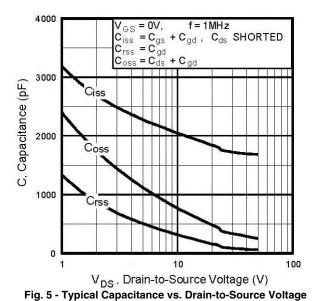


Fig. 4 - Normalized On-Resistance vs. Temperature

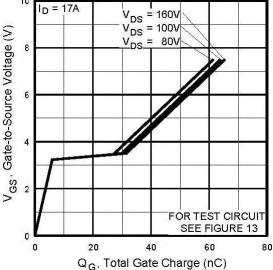
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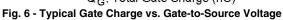




(A) The Transport of the Property of the Prope

 $V_{SD}\,,\,Source\mbox{-to-Drain Voltage}\;(V)$  Fig. 7 - Typical Source-Drain Diode Forward Voltage





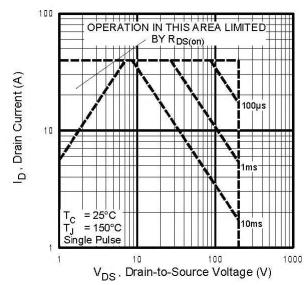


Fig. 8 - Maximum Safe Operating Area





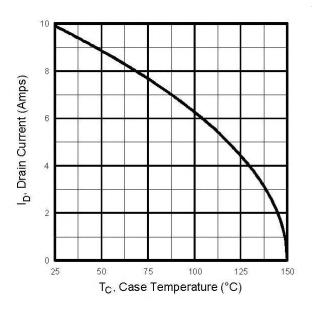


Fig. 9 - Maximum Drain Current vs. Case Temperature

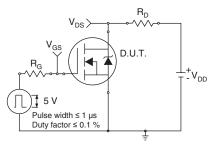


Fig. 10a - Switching Time Test Circuit

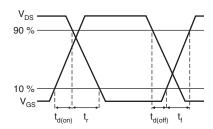


Fig. 10b - Switching Time Waveforms

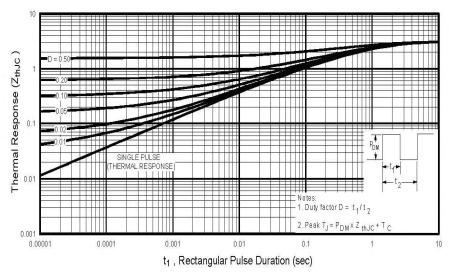


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

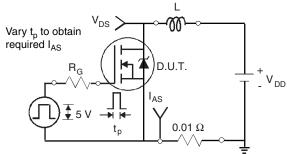


Fig. 12a - Unclamped Inductive Test Circuit

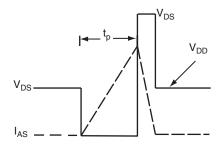


Fig. 12b - Unclamped Inductive Waveforms

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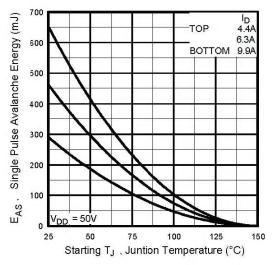


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

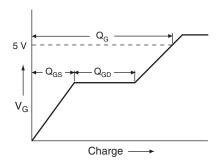


Fig. 13a - Basic Gate Charge Waveform

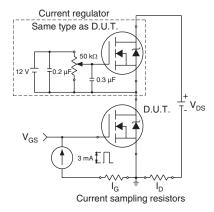
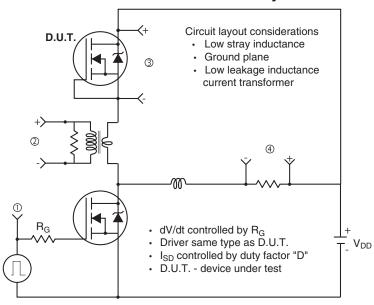
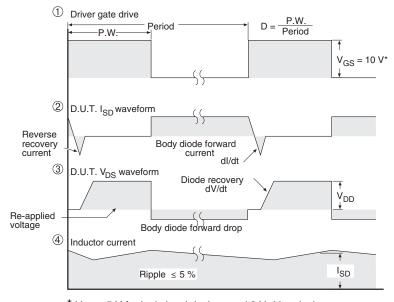


Fig. 13b - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit





 $^{\star}$  V<sub>GS</sub> = 5 V for logic level devices and 3 V drive devices

Fig. 14 - For N-Channel

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